

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

atent Application missioner for Patents Washington, D.C. 20231

Re: Inventor(s):

Yuen, et al

Title:

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Etching a Substrate in a Process Zone

Transmitted herewith is the patent application identified above, including:

☑ Specification, claims and abstract, totaling 34 pages.

rawings totaling 6 pages, X Formal Informal.

xecuted Declaration and Power of Attorney. 

formation Disclosure Statement, PTO-1449 form, and copies of citations

ssignment of the invention to Applied Materials, Inc. and Assignment Recordation Cover Sheet

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in the second second		FEE CALCULAT		Fee Rate	Total
Fee Items	Claims Filed	Included with Basic Fee	34	x 18.00	\$612.00
Claims	54	- 3 =	5	x 80.00	\$400.00 \$710.00
pendent Claims	8			710.00	\$1,722.00
Filing Fee					

- ☑ The Commissioner is hereby authorized to charge \$1722.ooto Deposit Account No. 50-1074.
- ☑ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074. A duplicate copy of this transmittal is enclosed.
- ☑ Please address all future correspondence to:

APPLIED MATERIALS, INC.

Patent Department

P.O. Box 450A

Santa Clara, CA 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope

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Robert W. Mulcahy

Registration No. 25,436